

L Number	Hits	Search Text	DB	Time stamp
1	1620	"dual damascene" and etch\$3	USPAT; US-PGPUB; EPO; JPO	2002/07/19 09:40
6	110	("dual damascene" and etch\$3) and "etch mask"	USPAT; US-PGPUB; EPO; JPO	2002/07/19 09:40
11	103	((("dual damascene" and etch\$3) and "etch mask") and (vias via trenches trench))	USPAT; US-PGPUB; EPO; JPO	2002/07/19 09:42
16	101	((("dual damascene" and etch\$3) and "etch mask") and (vias via trenches trench)) and pattern\$3	USPAT; US-PGPUB; EPO; JPO	2002/07/19 09:42
21	39	((("dual damascene" and etch\$3) and "etch mask") and (vias via trenches trench)) and pattern\$3) and "low k"	USPAT; US-PGPUB; EPO; JPO	2002/07/19 09:49
26	1511	convert\$3 near6 dielectric	USPAT; US-PGPUB; EPO; JPO	2002/07/19 09:54
31	452	(convert\$3 near6 dielectric) and etch\$	USPAT; US-PGPUB; EPO; JPO	2002/07/19 09:55
36	59	((convert\$3 near6 dielectric) and etch\$) and ("etch mask" "etch stop")	USPAT; US-PGPUB; EPO; JPO	2002/07/19 09:55